

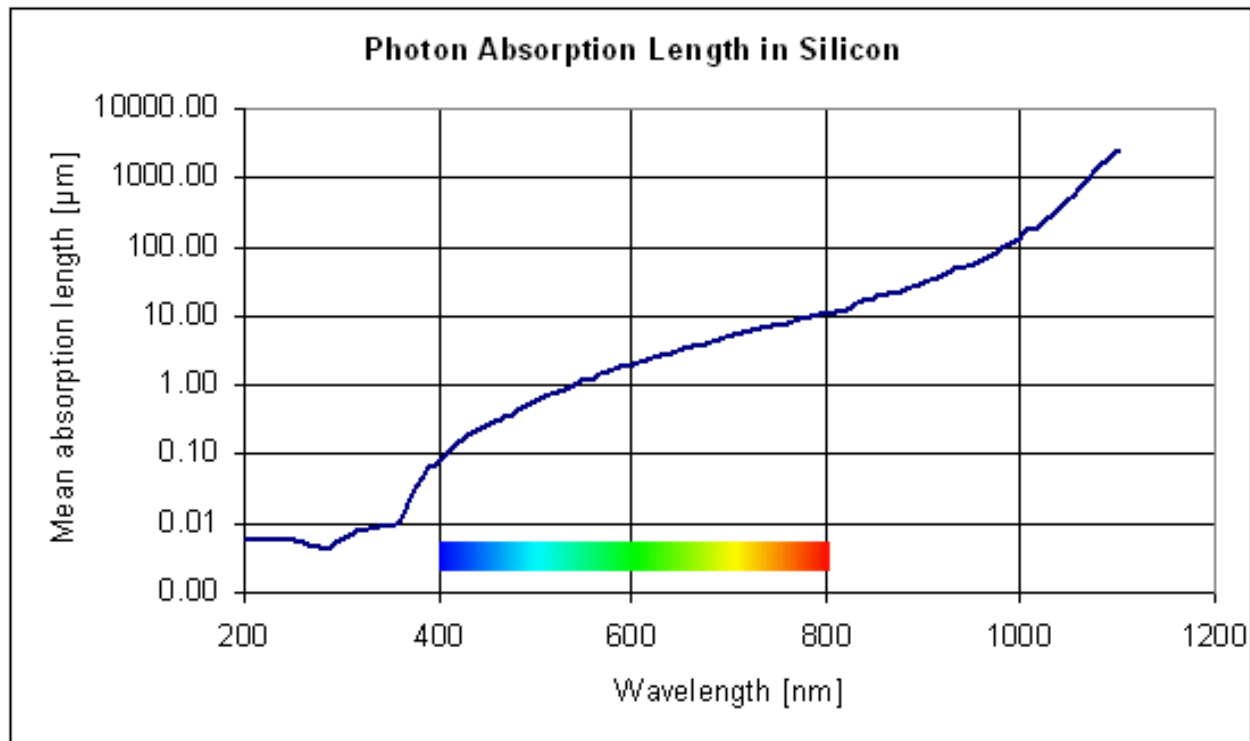
SiPM

a short introduction

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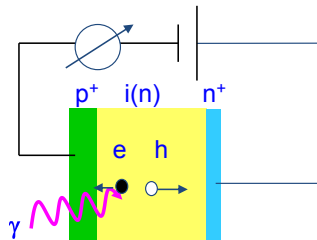
PHOTON ABSORPTION LENGTH IN SI

- ◆ Photon crossing silicon slice can transfer its energy to a valence electron generating an electron-hole pair
- ◆ The photon absorption length is function of the photon wavelength (or energy)
- ◆ Silicon is a good photo detector material for $400 \text{ nm} < \lambda < 800 \text{ nm}$ (above 1000 nm the silicon detector would be too bulky, below 350 nm the silicon would be too thin)



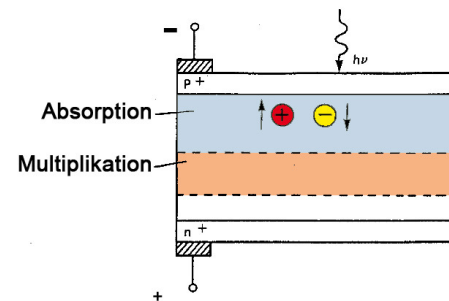
PIN & APD

- ◆ Diode reverse biased \rightarrow depletion region
- ◆ Electrons-holes generated by absorbed photons results in a current (electrons \rightarrow n-type, holes \rightarrow p-type)
- ◆ Different behavior according to the doping profile and applied voltage



PHOTODIODE (PIN DIODE)

- P(I)N type
- P layer $< 1\mu$
- High QE (80% @ $\lambda = 700\text{ nm}$)
- Gain=1

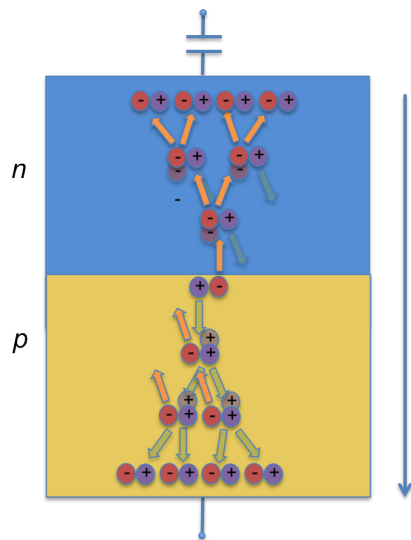


AVALANCHE PHOTODIODE (APD)

- High reverse bias voltage (few hundred of volt)
- Special doping profile \rightarrow high internal Field ($> 10^5\text{ V/cm}$) \rightarrow avalanche multiplication
- Typical gain ≈ 100
- Gain fluctuations due to avalanche process
- High sensitivity on temp and bias voltage ($\Delta G \approx 3\%/V - \Delta G \approx 2.5\%/K$)

THE GEIGER MODE IN SILICON (I)

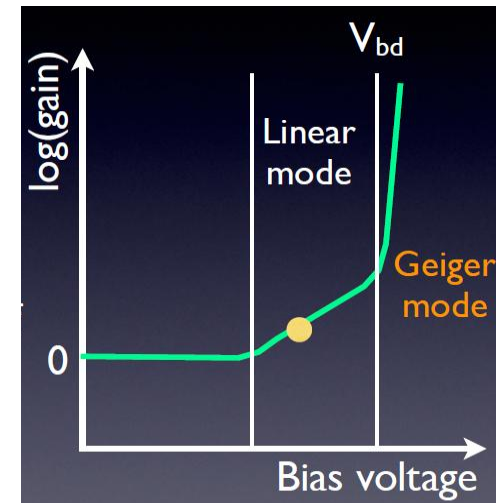
- ◆ High electric field ($> 5 \times 10^5 \text{ V/cm}$) in the depletion region accelerates charge carriers
- ◆ Charge carriers acquire enough kinetic energy to create secondary charge pairs (impact ionization process)
- ◆ Single photoelectron can generate self-sustaining cascade through the silicon
- ◆ The original photoelectron is amplified into a current flow
- ◆ Because the analogy of ionization discharge in gases (Geiger Muller Tube) the process is called Geiger discharge



Electric Field

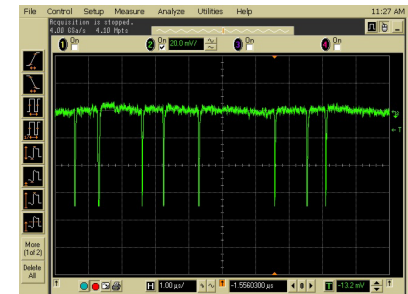
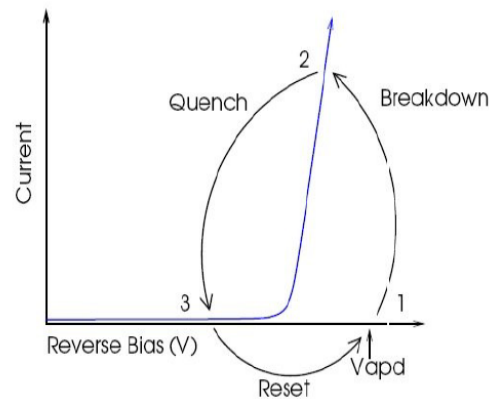
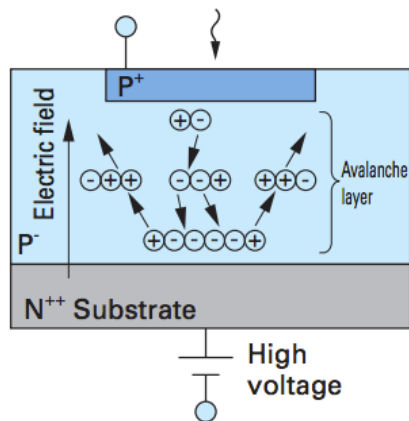


HIGH ELECTRIC FIELD



THE GEIGER MODE IN SILICON (II)

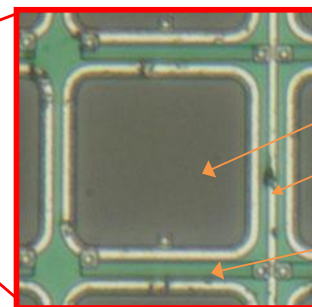
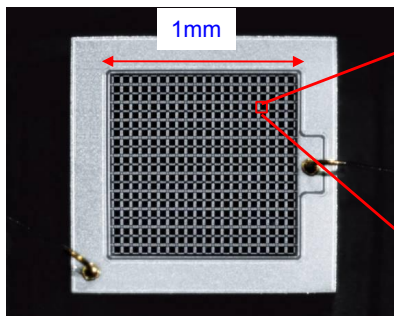
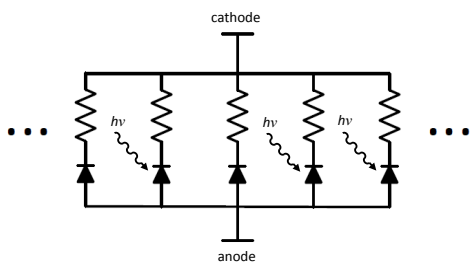
- ◆ p-n region designed to sustain reverse bias besides his nominal breakdown voltage
- ◆ **Flowing current is stopped through a passive quenching circuit (resistors)**



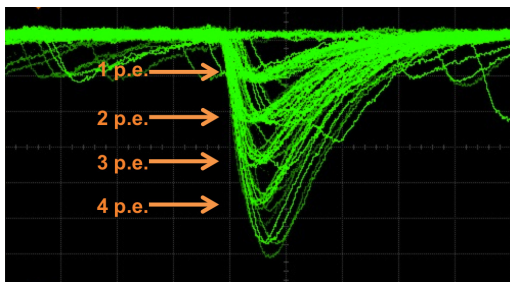
- ◆ A single photodiode acts as a photon-triggered switch
- ◆ The photodiode can not provide proportional magnitude information (i.e. if 1 or more photons hit the same cell produce the same signal)

THE SILICON PHOTO MULTIPLIER (SIPM)

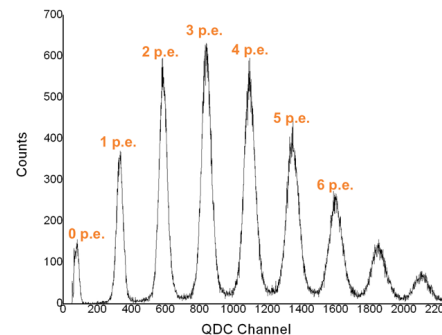
- ◆ To mitigate the lack of proportionality an array of optical isolated Geiger-mode photodiodes has been built each one with his own quenching resistor
- ◆ The number of photodiodes range from 100 and 1000 per mm²
- ◆ The signals of all photodiodes are then summed



GM-APD
BIAS BUS
QUENCH RESISTOR



SPECTRUM
OSCILLOSCOPE



THE SiPM GAIN

- ◆ Matrix of Nmicro-cells (“pixels”) in parallel, connected to a common output node
- ◆ Each micro-cell: GM-APD+R_{QUENCING}
- ◆ V.M. Golovin and A.Sadygov (Russian patents | 1996-2002)

A single GM-APD do not produce information about the light intensity. In a SiPM the output charge is proportional to the number of triggered cells or, assuming a CONVERSION EFFICIENCY = 1, to the number of photons hitting different cells.

GAIN: number of carriers produced by an absorbed photon. Collected charge correspond to the area of the output signal and can be estimated according to the circuit element and bias

$$I_{MAX} \cdot \frac{\tau_Q}{q} = \frac{(V_{BIAS} - V_{BD})}{R_Q} \cdot \frac{\tau_Q}{q} = \frac{(V_{BIAS} - V_{BD}) \cdot C_D}{q}$$

- V_{BIAS} = Supply voltage
- V_{BD} = Breakdown Voltage
- C_D = Device Capacitance
- R_Q = Quencing resistor

SIPM NOISE & PHOTO DETECTION EFFICIENCY (PDE)

NOISE

- ◆ **Primary dark count:** current pulses triggered by non-photogenerated carriers (main source of dark carriers: thermal generation in the depleted region)
- ◆ **After-pulsing:** secondary current pulse caused by a carrier trapped during the primary avalanche and released after a certain time
- ◆ **Optical cross-talk:** excitation of neighboring cells due to photoemission during avalanche discharges

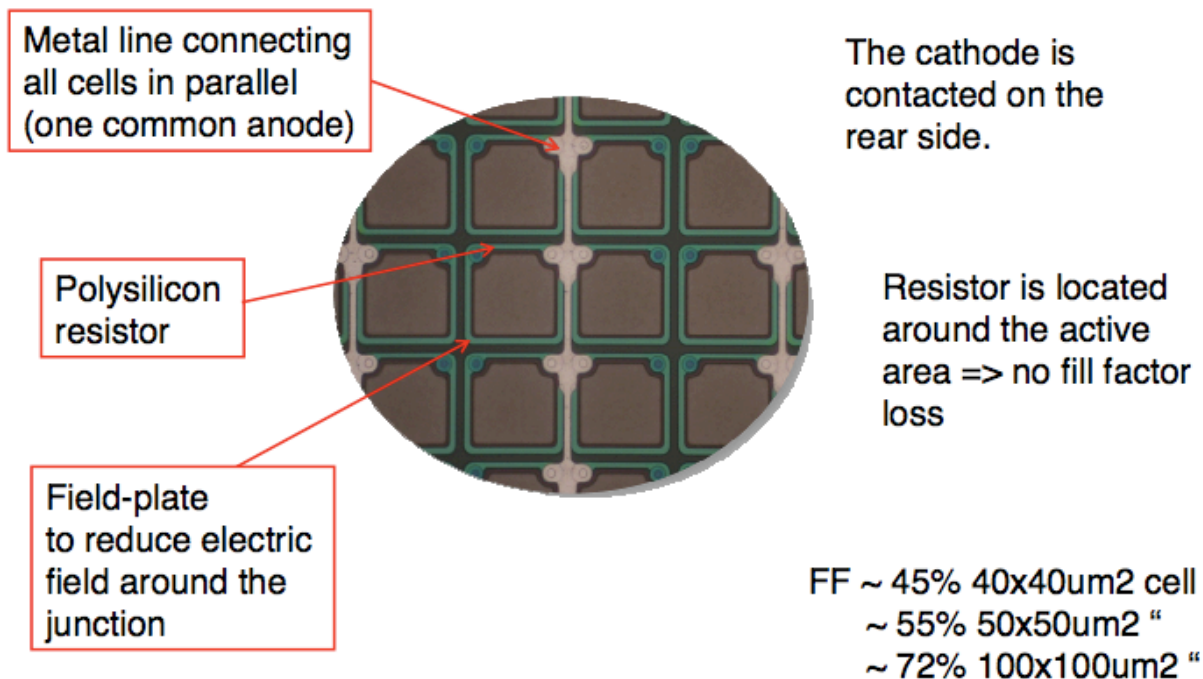
PDE: $N_{\text{PULSES}}/N_{\text{PHOTONS}} = \text{QE} \times A_{\text{TP}} \times \text{FF}$

- QE = Quantum Efficiency ≈ 1 in the blue-green region
- A_{TP} = Geiger-APD Avalanche Trigger Probability > 0.95 when $(V_{\text{BIAS}} - V_{\text{BD}})/V_{\text{BIAS}} > 0.15$
- FF = Fill Factor = 0.2 - 0.8

Producer	SiPM ID	No. μ cells	μ cell size (μm)	ϵ_{geom} (%)
Photonic	SSPM-0701-BG	556	43 \times 43	70
FBK-irst	W20-B10-T3V2PD/I run	625	40 \times 40	20
FBK-irst	W3-B3-T6V1PD/II run	625	40 \times 40	16
SensL	SPM-20	848	29 \times 32	43
SensL	SPM-35	400	44 \times 47	59
SensL	SPM-50	216	59 \times 62	68
HPK	S10362-11-25	1600	25 \times 25	31
HPK	S10362-11-50	400	50 \times 50	61.6
HPK	S10362-11-100	100	100 \times 100	78.5

SIPM PDE - FILL FACTOR

- ◆ Metal lines connecting the cells, poly-silicon resistors, thrences and implantation profile reduce the sensitive area
- ◆ Fill Factor increase with increasing cell size (up to 70/80%)



SUMMARIZING

TYPE	GAIN	MIN DETECT SIGNAL (PE)	BANDWIDTH (order of)	MAX SIZE (order of)
PIN	NO	200-300	100 kHz	10 cm ²
APD	LINEAR (50-200)	10-20	100 MHz	2.5 cm ²
SIPM	GEIGER (10 ⁵ -10 ⁶)	1	100 MHz	< 1 cm ²

SiPM PROS

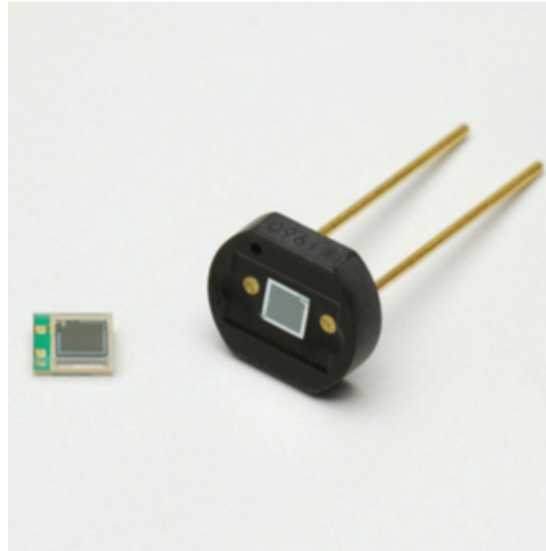
- High photo detection efficiency
- High gain (10⁵-10⁶)
- Single photo-detection sensitivity
- Fast (≈ 1 ns rise time)
- Good time resolution (< 100 ps)
- Low bias voltages (< 100 V)
- B field insensitivity

SiPM CONS

- Limited linearity
- Dark count
- Surface Area
- Temperature dependence

S18825 HAMAMATSU MPPC

Multi-Pixel Photon Counter



Structure

Parameters	Symbol	S12825-050C	S12825-050P	Unit
Effective photosensitive area	-	1.3 x 1.3		mm ²
Pixel pitch	-	50		μm
Number of pixels / channel	-	667		-
Geometrical fill factor	-	62		%
Package	-	Ceramic	Surface mount type	-
Window	-	Silicone resin	Epoxy resin	-
Window refractive index	-	1.41	1.55	-

S18825 HAMAMATSU MPPC

Multi-Pixel Photon Counter

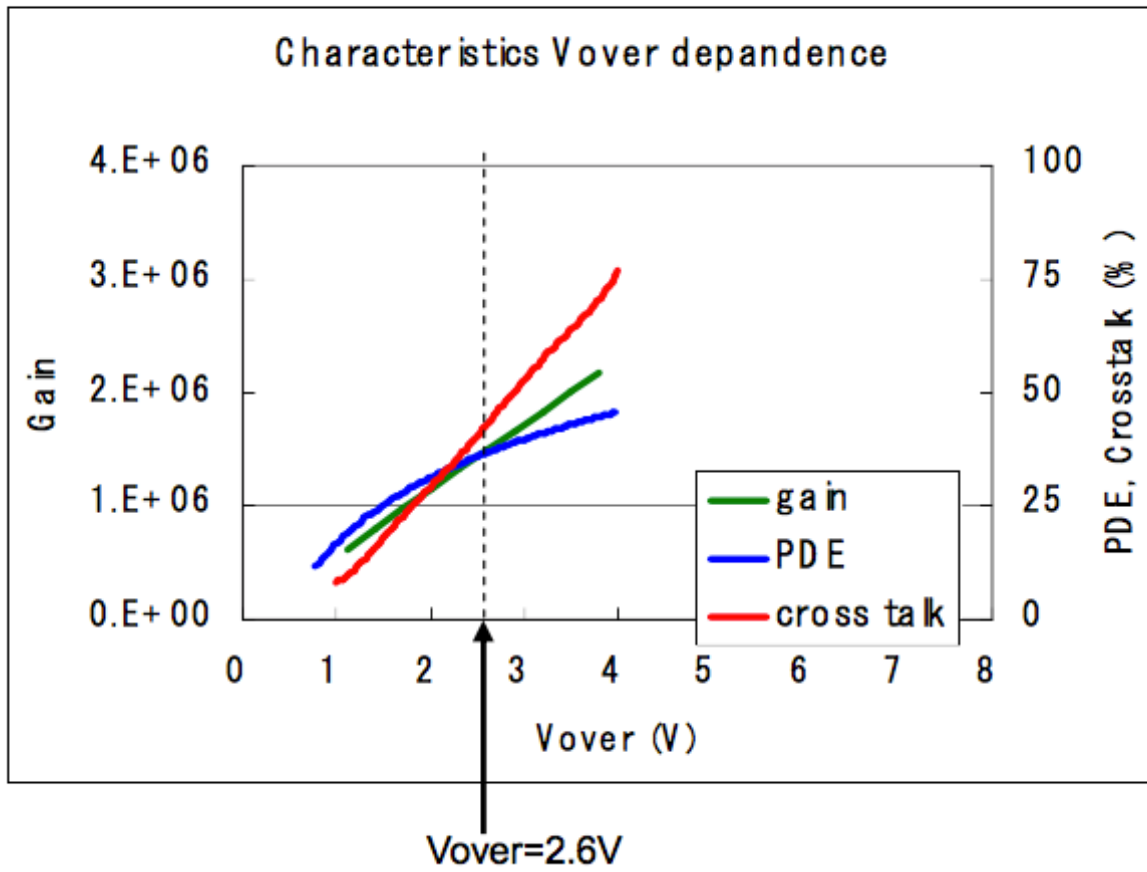
Electrical and optical characteristics (Typ. Ta=25 deg C, Vover=2.6^{*1} Unless otherwise noted)

Parameters	Symbol	S12825-050C, S12825-050P	Unit
Spectral response range	λ	320 to 900	nm
Peak sensitivity wavelength	λ_p	450	nm
Photon detection efficiency at λ_p ^{*4}	PDE	35	%
Dark count	Typ.	170	kcps
	Max	350	kcps
Terminal capacitance	Ct	60	pF
Gain ^{*5}	M	1.25×10^6	
Breakdown voltage	VBR	65±10V	
Recommended operating voltage ^{*6}	Vop	V _{BR} +2.6	V
Temperature coefficient of recommended reverse voltage	ΔTV_{op}	60	mV/°C

SI 8825 HAMAMATSU MPPC

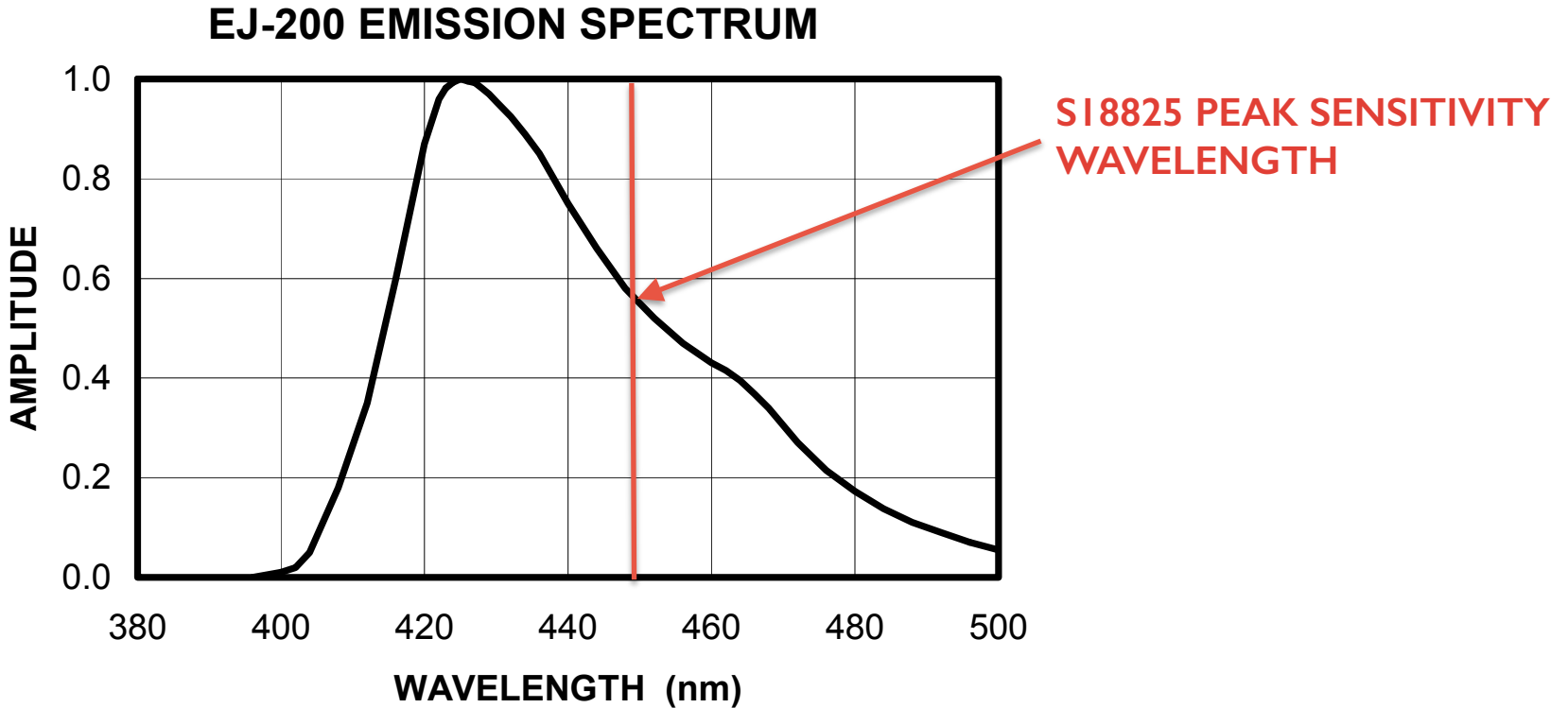
Multi-Pixel Photon Counter

Operation voltage dependence



PDE: measured at $\lambda=408\text{nm}$
(not including cross talk and after pulse)

SI 8825 HAMAMATSU PEAK SENSITIVITY vs EJ200 PEAK EMISSION SPECTRUM



**SCINTILLATOR PEAK EMISSION AND
SiPM PEAK SENSITIVITY DO NOT MATCH**



WLS REQUIRED

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- ◆ Silicon Detectors – Photo Detectors - P. Fischer, ziti, Uni Heidelberg, Seite, Heidelberg
- ◆ SiPM: feature and applications - Giulio Saracino – University of Naples Federico II